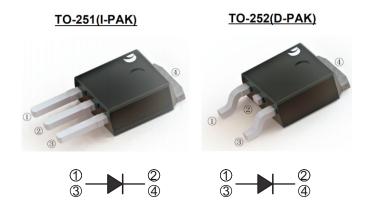
Surface Mount Super fast Recovery Rectifier Reverse Voltage – 800 V Forward Current – 5.0 A

FEATURES

- High current capability
- Low forward voltage drop
- Low power loss, high efficiency
- High surge capability
- High temperature soldering guaranteed
- Mounting position: any



MAXIMUM RATINGS AND ELECTRICAL CHARACTERISTICS

Ratings at 25°C ambient temperature unless otherwise specified

CHARACTERISTICS	TO-251	SF508VS						
CHARACTERISTICS	TO-252	SF508DS	Units					
Maximum Recurrent Peak Reverse Voltage	V_{RRM}	800	V					
Maximum RMS voltage	V _{RMS}	560	V					
Maximum DC Blocking Voltage	V _{DC}	800	V					
Maximum Average Forward Rectified Current	I _{F(AV)}	5.0	А					
Peak Forward Surge Current,8.3ms Single Half Sine-wave Superimposed on Rated Load (JEDEC method)	I _{FSM}	150	А					
Max Instantaneous Forward Voltage at 5 A	V _F	2.30	V					
Maximum DC Reverse Current $T_a = 25^{\circ}$ C at Rated DC Reverse Voltage $T_a = 125^{\circ}$ C	I _R	1 300	uA					
Typical Junction Capacitance f=1MHz,4V DC	C _j	45	pF					
Typical Thermal Resistance (1)	R _{θJA}	15	°C/W					
Maximum Reverse Recovery Time (2)	t _{rr}	35	ns					
Operating Junction Temperature Range	Tj	-55 ~ +150	°C					
Storage Temperature Range	T_{stg}	-55 ~ +150	°C					

^(1) P.C.B. mounted with $\,$ 10cm x 10cm x 1mm copper pad areas.

^(2) Measured with $\rm I_{\scriptscriptstyle F}$ = 0.5 A, $\rm I_{\scriptscriptstyle R}$ = 1 A, $\rm I_{\scriptscriptstyle rr}$ = 0.25 A.

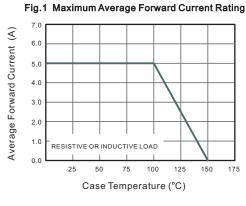
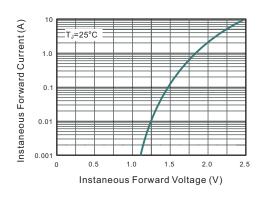


Fig.3 Typical Forward Characteristics



Forward Surage Current Peak Forward Surage Current (A) 150 120 90

Fig.5 Maximum Non-Repetitive Peak



100

8.3 ms Single Half Sine Wave (JEDEC Method)

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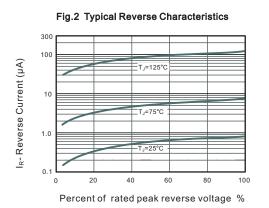
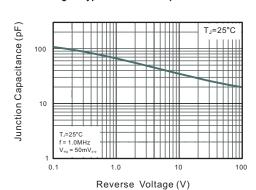
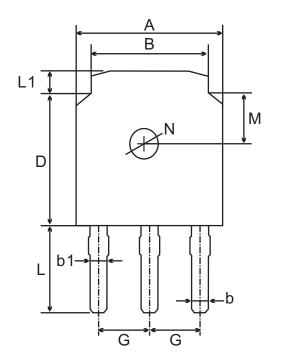
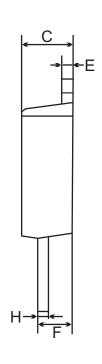


Fig.4 Typical Junction Capacitance



TO-251(I-PAK) Package Outline Dimensions





TO-251(I-PAK) mechanical data

UN	NIT.	А	В	b	b1	С	D	E	F	G	Н	L	L1	М	N
mm	max	6.7	5.5	0.8	0.9	2.5	6.3	0.6	1.8	2.29	0.55	4.3	1.2	1.8	1.3 TYPICAL
'''''	min	6.3	5.1	0.3	0.76	2.1	5.9	0.4	1.3	TYPICAL	0.45	3.9	0.8	TYPICAL	
mil	max	264	217	31	35	98	248	24	71	90 TYPICAL	22	169	47	71	51
mii	min	248	201	12	30	83	232	16	51			18	154	31	TYPICAL

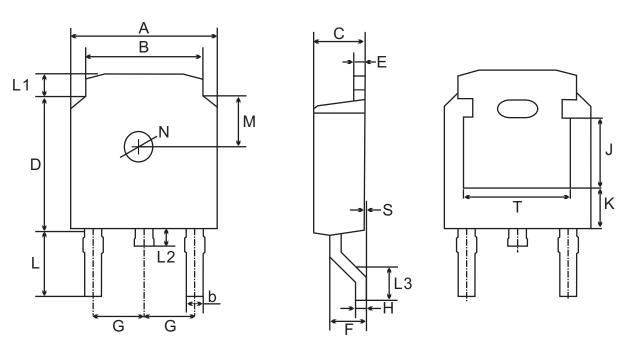
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TO-252(D-PAK) Package Outline Dimensions



TO-252(D-PAK) mechanical data

UN	VIT.	Α	В	b	С	D	Е	F	G	Н	L	L1	L2	L3	S	М	N	J	K	Т
	max	6.7	5.5	0.8	2.5	6.3	0.6	1.8	2.29	0.55	3.1	1.2	1.0	1.75	0.1	1.8 TYPICAL				4.83
mm	min	6.3	5.1	0.3	2.1	5.9	0.4	1.3	TYPICAL	0.45	2.7	0.8	0.6	1.40	0.0					ref.
	max	264	217	31	98	248	24	71	90	22	122	47	39	69	4	71	51	124	71	190
mil	min	248	201	12	83	232	16	51	TYPICAL	18	106	31	24	55	0	TYPICAL	TYPICAL	ref.	ref.	ref.

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